

PLATE-LIKE OBJECT PROCESSING METHOD

ABSTRACT OF THE DISCLOSURE

A plate-like object processing method for processing a plate-like object including a substrate and a laminate formed on a front surface of the substrate, includes a substrate exposing step of exposing the substrate by removing the laminate by irradiating a region in which the laminate of the plate-like object is desired to be removed with a laser beam set at an energy density that destroys the laminate but does not destroy the substrate.

(Figure 5D)